WNSC2D021200D

Silicon Carbide Diode

Rev.01 - 20 May 2022

Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO252 (DPAK) plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- · Superior in efficiency to Silicon Diode alternatives
- · Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T_{j(max)} = 175 °C)

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data							
Symbol	Parameter	Conditions	Values			Unit		
Absolute	maximum rating							
V_{RRM}	RRM repetitive peak reverse voltage				1200			
$I_{F(AV)}$	average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 157 °C; Fig. 1; Fig. 2; Fig. 3	2		A			
T _j	junction temperature		175		°C			
Symbol	Parameter	Conditions	Notes	Notes Min Typ Max		Unit		
Static ch	aracteristics							
V _F	forward voltage	I _F = 2 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.45	1.65	V	
		I _F = 2 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.95	2.30	V	
Dynamic	characteristics	·						
Q _r	recovered charge	I _F = 2 A; dI _F /dt = 500 A/μs; V _R = 400 V; T _j = 25 °C; <u>Fig. 7</u>		-	8	-	nC	



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5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	not connected		
2	К	cathode [1]		K — A 001aaa020
3	А	anode		
mb	К	mounting base; connected to cathode		

[1] It is not possible to connect to pin 2 of the TO252 package.

6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	name		method	quantity	version	issue date		
WNSC2D021200D	TO252	WNSC2D021200D6J	Reel	2500	TO252NS	14-Nov-2016		

7. Marking

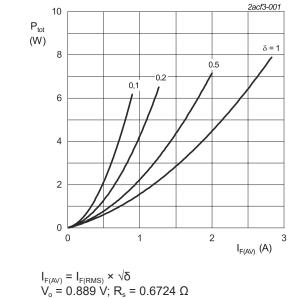
Table 4. Marking codes					
	Type number	Marking codes			
	WNSC2D021200D	WNSC2D			
		02120D			

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		1200	V
V_{RWM}	crest working reverse voltage		1200	V
V _R	reverse voltage	DC	1200	V
$I_{F(AV)}$	average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 157 °C; Fig. 1; Fig. 2; Fig. 3	2	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 µs; T _{mb} ≤ 157 °C; square-wave pulse	4	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	20	А
	forward current	t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse	200	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms	2	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C



 $V_o = 0.889 V$; $R_s = 0.6724 \Omega$ Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

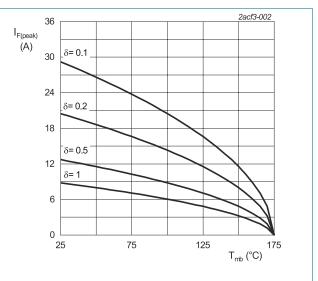
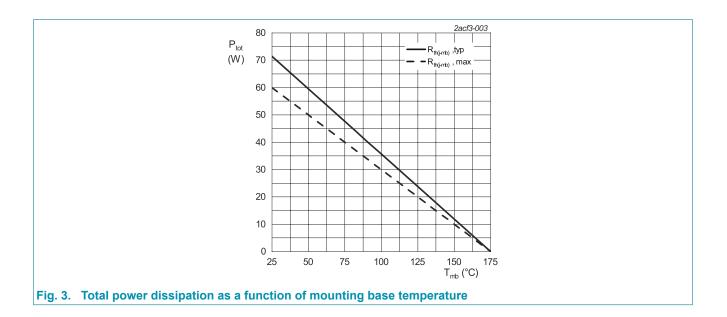


Fig. 2. Current derating as a function of mounting base temperature

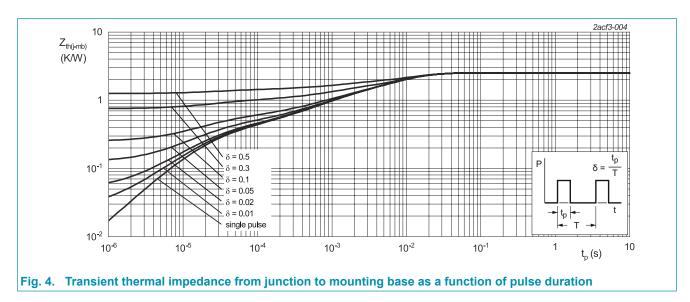
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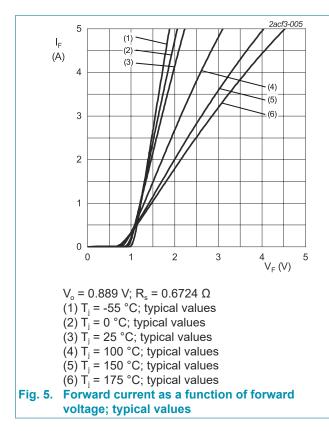
9. Thermal characteristics

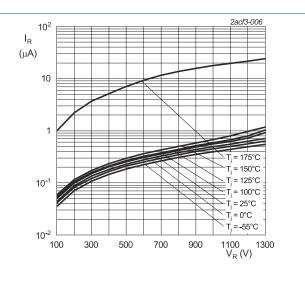
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	with heatsink compound; Fig. 4		-	2.1	2.5	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	50	-	K/W



10. Characteristics

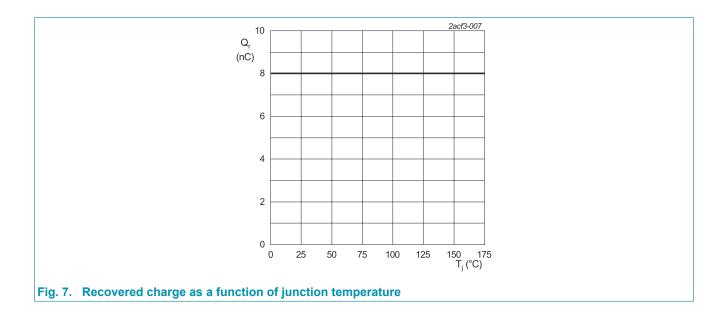
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics				·		
V _F	forward current	I _F = 2 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.45	1.65	V
		I _F = 2 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.95	2.30	V
		I _F = 2 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.10	2.60	V
I _R	reverse current	V _R = 1200 V; T _j = 25 °C; <u>Fig. 6</u>		-	0.5	10	μA
		V _R = 1200 V; T _j = 175 °C; <u>Fig. 6</u>		-	25	250	μA
Dynamic	characteristics		-				
Q _r	recovered charge	$I_F = 2 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	8	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C		-	95	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C		-	10	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C		-	8	-	pF
E _{as}	non-repetitive avalanche energy	I _R = 2.4 A; L = 10 mH; T _{j(init)} = 25 °C		28.8	-	-	mJ



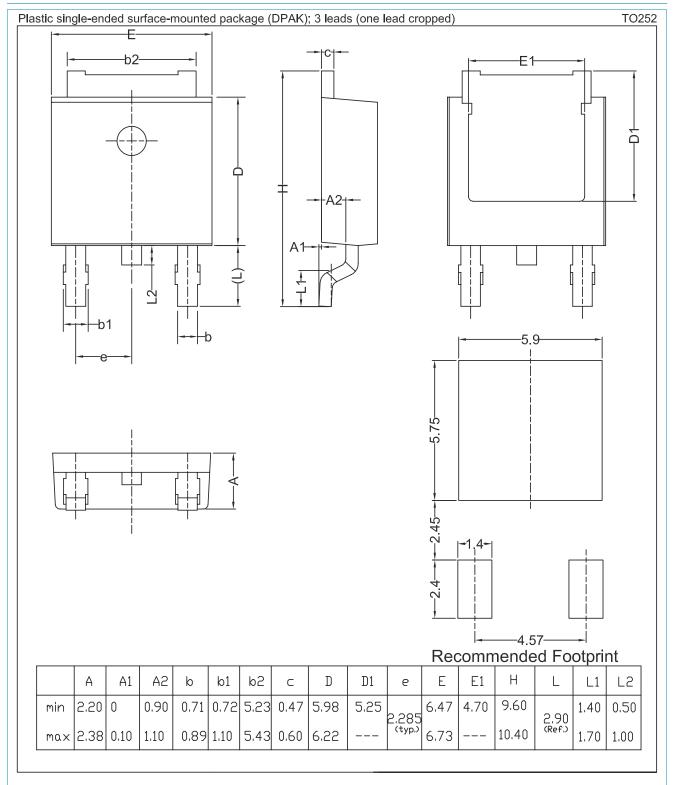




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11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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